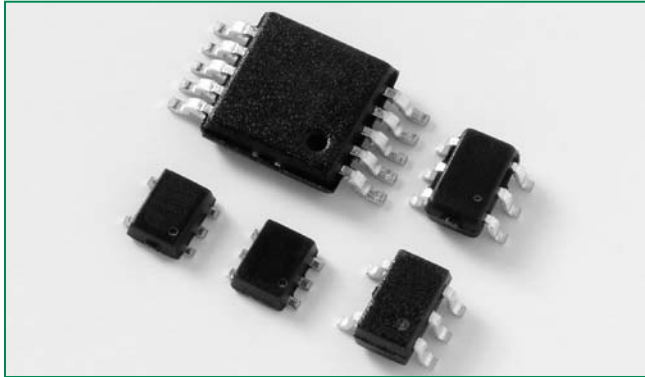


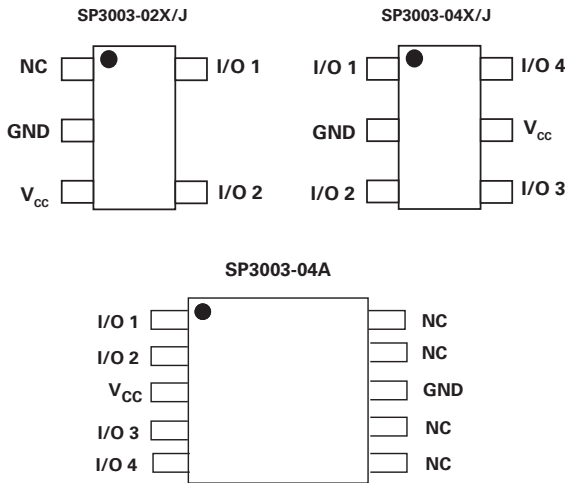
**RoHS** **Pb** **GREEN** **SP3003 Lead-Free/Green Series**



**Description**

The SP3003 has ultra low capacitance rail-to rail diodes with an additional zener diode fabricated in a proprietary silicon avalanche technology to protect each I/O pin providing a high level of protection for electronic equipment that may experience destructive electrostatic discharges (ESD). These robust diodes can safely absorb repetitive ESD strikes at the maximum level specified in the IEC 61000-4-2 international standard (Level 4, 8KV contact discharge) without performance degradation. Their very low loading capacitance also makes them ideal for protecting high speed signal pins such as HDMI, DVI, USB2.0, and IEEE 1394.

**Pinout**



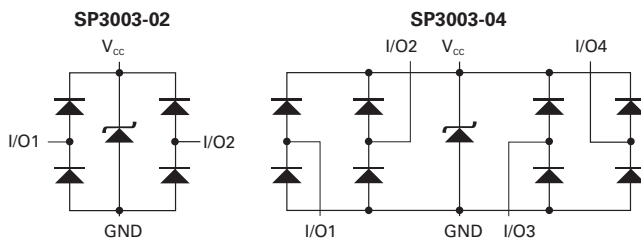
**Features**

- Low capacitance of 0.65pF (TYP) per I/O
- ESD protection of ±8kV
- EFT protection, IEC61000-4-4, 40A (5/50 ns)
- Low leakage current of 0.5µA (MAX) at 5V
- Small packages save board space (SC70, SOT553, SOT563, MSOP10)

**Applications**

- Computer Peripherals
- Mobile Phones
- PDAs
- Digital Cameras
- Network Hardware/Ports
- Test Equipment
- Medical Equipment

**Functional Block Diagram**



Lead-Free/Green SP3003

### Absolute Maximum Ratings

Symbol	Parameter	Value	Units
$I_P$	Peak Current ( $t_p=8/20\mu s$ )	2.5	A
$T_{OP}$	Operating Temperature	-40 to 85	°C
$T_{STOR}$	Storage Temperature	-50 to 150	°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### Thermal Information

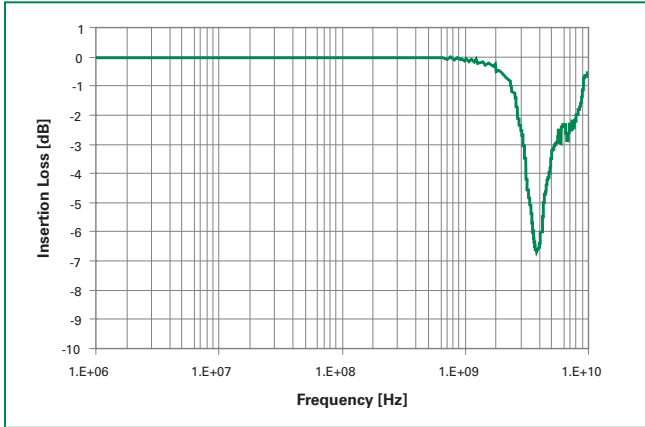
Parameter	Rating	Units
Storage Temperature Range	-65 to 150	°C
Maximum Junction Temperature	150	°C
Maximum Lead Temperature (Soldering 10s)	300	°C

### Electrical Characteristics ( $T_{OP}=25^\circ C$ )

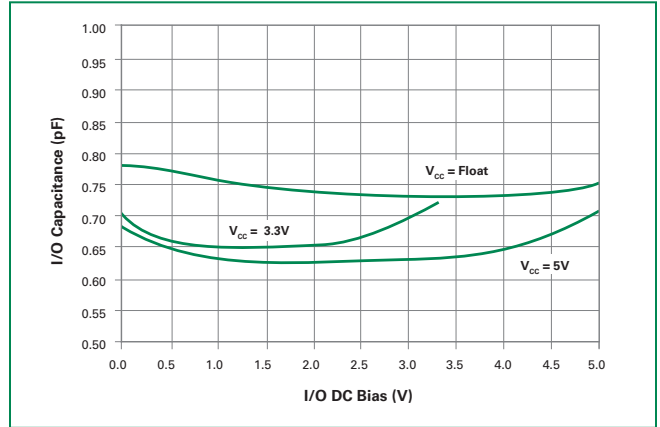
Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Zener Breakdown Voltage	$V_{BR}$	$I_R=10\mu A$	6.0			V
Reverse Leakage Current	$I_{LEAK}$	$V_R=5V$			0.5	$\mu A$
Clamp Voltage <sup>1</sup>	$V_C$	$I_{PP}=1A, t_p=8/20\mu s, Fwd$		10.0		V
		$I_{PP}=2A, t_p=8/20\mu s, Fwd$		11.8		V
ESD Withstand Voltage <sup>1</sup>	$V_{ESD}$	IEC61000-4-2 (Contact)	$\pm 8$			kV
		IEC61000-4-2 (Air)	$\pm 15$			kV
Diode Capacitance <sup>1</sup>	$C_{I/O-GND}$	Reverse Bias=0V		0.80		pF
		Reverse Bias=1.65V		0.65		pF
Diode Capacitance <sup>1</sup>	$C_{I/O-I/O}$	Reverse Bias=0V		0.35		pF

Note 1: Parameter is guaranteed by device characterization

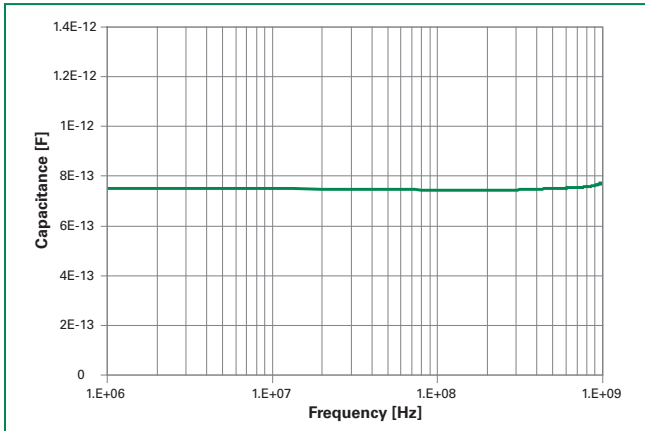
**Insertion Loss (S21) I/O to GND**



**Capacitance vs. Bias Voltage**

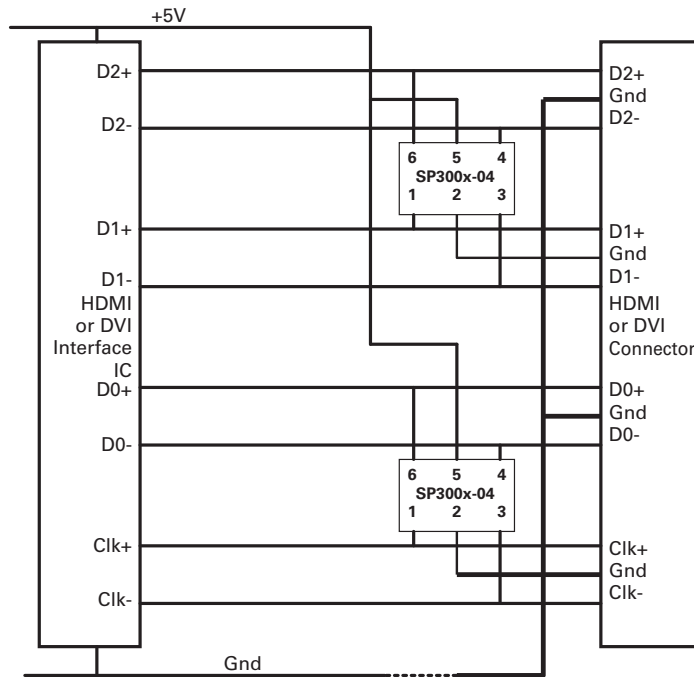


**Capacitance vs. Frequency**



Lead-Free/Green SP3003

### Application Example

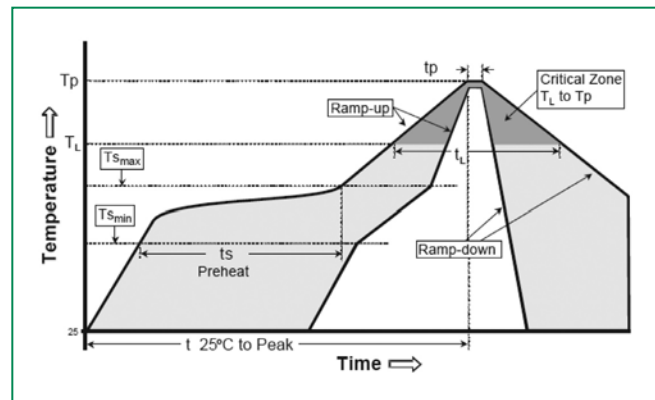


HDMI or DVI application example for the Littelfuse SP300x-04 protection devices. A single 4 channel SP300x-04 device can be used to protect four of the data lines in a HDMI/DVI interface. Two (2) SP300x-04 devices provide protection for the main data lines. Low voltage

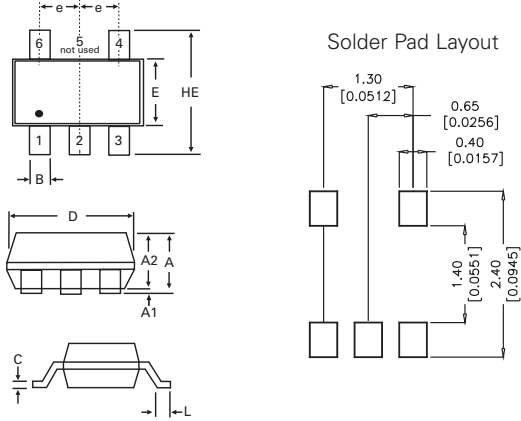
ASIC HDMI/DVI drivers can also be protected with the SP300x-04, the +V<sub>CC</sub> pins on the SP300x-04 can be substituted with a suitable bypass capacitor or in some backdrive applications the +V<sub>CC</sub> of the SP300x-04 can be floated or NC.

### Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	- Temperature Min ( $T_{s(min)}$ )	150°C
	- Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (min to max) ( $t_s$ )	60 – 180 secs
Average ramp up rate (Liquidus) Temp ( $T_L$ ) to peak		3°C/second max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/second max
Reflow	- Temperature ( $T_L$ ) (Liquidus)	217°C
	- Temperature ( $t_L$ )	60 – 150 seconds
Peak Temperature ( $T_p$ )		250 <sup>+0/-5</sup> °C
Time within 5°C of actual peak Temperature ( $t_p$ )		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature ( $T_p$ )		8 minutes Max.
Do not exceed		260°C

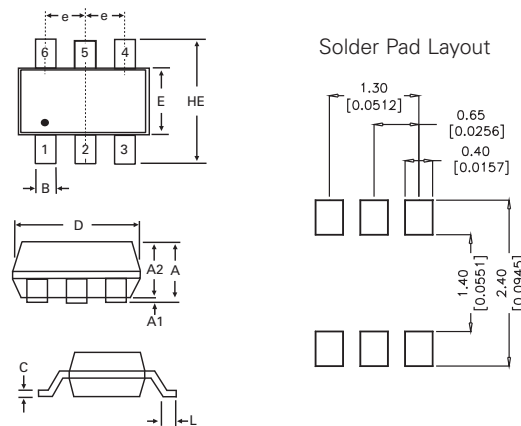


**Package Dimensions — SC70-5**



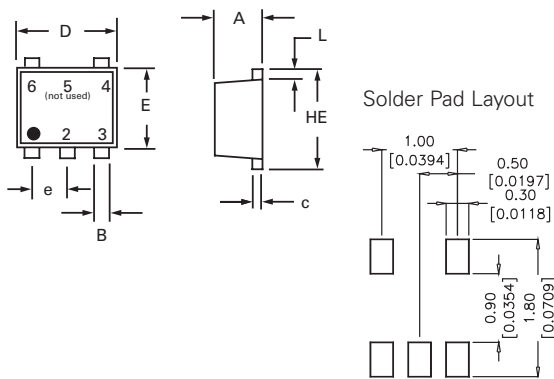
Package	SC70-5			
Pins	5			
JEDEC	MO-203 Issue A			
	Millimeters		Inches	
	Min	Max	Min	Max
<b>A</b>	0.80	1.10	0.031	0.043
<b>A1</b>	0.00	0.10	0.000	0.004
<b>A2</b>	0.70	1.00	0.028	0.039
<b>B</b>	0.15	0.30	0.006	0.012
<b>c</b>	0.08	0.25	0.003	0.010
<b>D</b>	1.85	2.25	0.073	0.089
<b>E</b>	1.15	1.35	0.045	0.053
<b>e</b>	0.65 BSC		0.026 BSC	
<b>HE</b>	2.00	2.40	0.079	0.094
<b>L</b>	0.26	0.46	0.010	0.018

**Package Dimensions — SC70-6**



Package	SC70-6			
Pins	6			
JEDEC	MO-203 Issue A			
	Millimeters		Inches	
	Min	Max	Min	Max
<b>A</b>	0.80	1.10	0.031	0.043
<b>A1</b>	0.00	0.10	0.000	0.004
<b>A2</b>	0.70	1.00	0.028	0.039
<b>B</b>	0.15	0.30	0.006	0.012
<b>c</b>	0.08	0.25	0.003	0.010
<b>D</b>	1.85	2.25	0.073	0.089
<b>E</b>	1.15	1.35	0.045	0.053
<b>e</b>	0.65 BSC		0.026 BSC	
<b>HE</b>	2.00	2.40	0.079	0.094
<b>L</b>	0.26	0.46	0.010	0.018

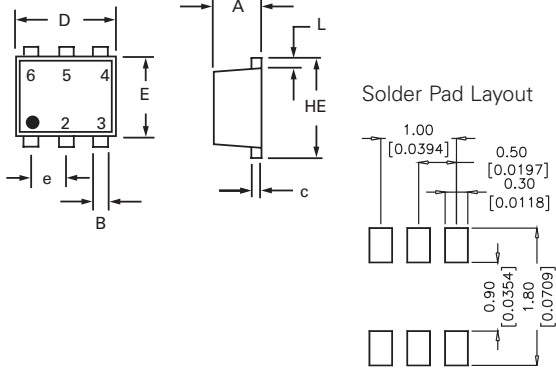
**Package Dimensions — SOT553**



Package	SOT 553			
Pins	5			
	Millimeters		Inches	
	Min	Max	Min	Max
<b>A</b>	0.50	0.60	0.020	0.024
<b>B</b>	0.17	0.27	0.007	0.011
<b>c</b>	0.08	0.18	0.003	0.007
<b>D</b>	1.50	1.70	0.059	0.067
<b>E</b>	1.10	1.30	0.043	0.051
<b>e</b>	0.50 BSC		0.020 BSC	
<b>L</b>	0.10	0.30	0.004	0.012
<b>HE</b>	1.50	1.70	0.059	0.067

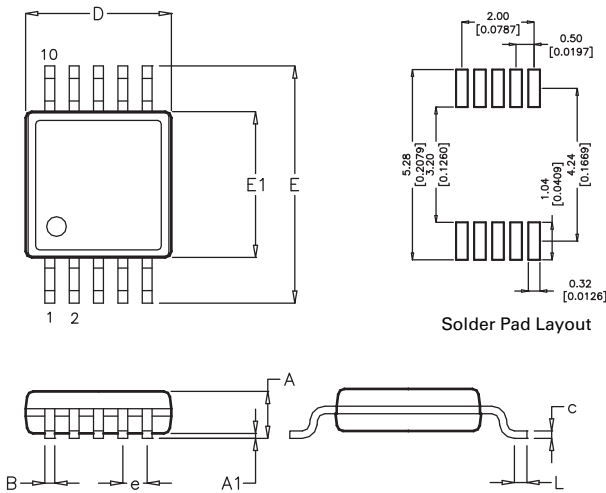
Lead-Free/Green SP3003

### Package Dimensions — SOT563



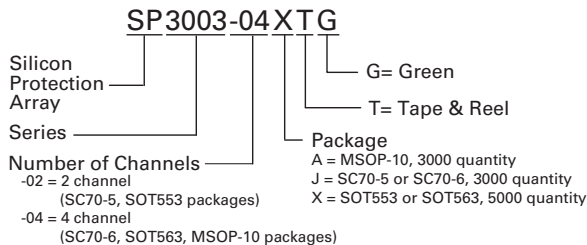
Package	SOT 563			
Pins	6			
	Millimeters		Inches	
	Min	Max	Min	Max
<b>A</b>	0.50	0.60	0.020	0.024
<b>B</b>	0.17	0.27	0.007	0.011
<b>c</b>	0.08	0.18	0.003	0.007
<b>D</b>	1.50	1.70	0.059	0.067
<b>E</b>	1.10	1.30	0.043	0.051
<b>e</b>	0.50 BSC		0.020 BSC	
<b>L</b>	0.10	0.30	0.004	0.012
<b>HE</b>	1.50	1.70	0.059	0.067

### Package Dimensions — MSOP10



Package	MSOP10			
Pins	10			
	Millimeters		Inches	
	Min	Max	Min	Max
<b>A</b>	-	1.10	-	0.043
<b>A1</b>	0.00	0.15	0.000	0.006
<b>B</b>	0.17	0.27	0.007	0.011
<b>c</b>	0.08	0.23	0.003	0.009
<b>D</b>	2.90	3.10	0.114	0.122
<b>E</b>	4.67	5.10	0.184	0.200
<b>E1</b>	2.90	3.10	0.114	0.122
<b>e</b>	0.50 BSC		0.020 BSC	
<b>HE</b>	0.40	0.80	0.016	0.032

### Part Numbering System



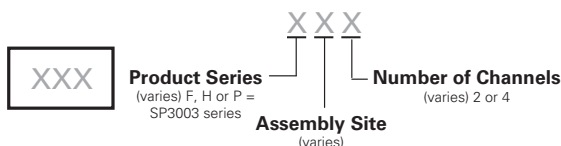
### Product Characteristics

<b>Lead Plating</b>	Matte Tin
<b>Lead Material</b>	Copper Alloy
<b>Lead Coplanarity</b>	0.0004 inches (0.102mm)
<b>Substitute Material</b>	Silicon
<b>Body Material</b>	Molded Epoxy
<b>Flammability</b>	UL94-V-0

Notes :

1. All dimensions are in millimeters
2. Dimensions include solder plating.
3. Dimensions are exclusive of mold flash & metal burr.
4. All specifications comply to JEDEC SPEC MO-223 Issue A
5. Blo is facing up for mold and facing down for trim/form, i.e. reverse trim/form.
6. Package surface matte finish VDI 11-13.

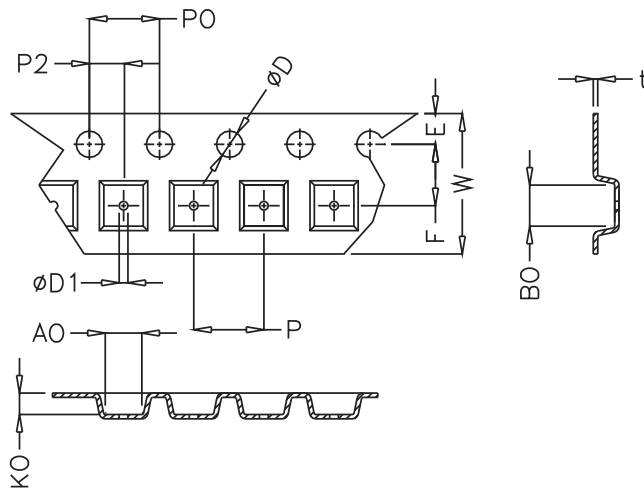
### Part Marking System



**Ordering Information**

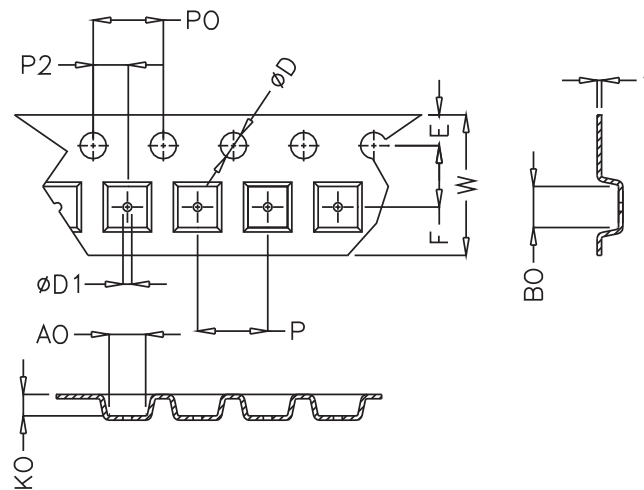
Part Number	Package	Marking	Min. Order Qty.
SP3003-02JTG	SC70-5	FX2	3000
SP3003-02XTG	SOT553	FX2	5000
SP3003-04ATG	MSOP-10	FX4	3000
SP3003-04JTG	SC70-6	FX4	3000
SP3003-04XTG	SOT563	FX4	5000

**Embossed Carrier Tape & Reel Specifications - SC70-5 and SC70-6**



	Millimetres		Inches	
	Min	Max	Min	Max
<b>E</b>	1.65	1.85	0.064	0.072
<b>F</b>	3.45	3.55	0.135	0.139
<b>P2</b>	1.95	2.05	0.076	0.080
<b>D</b>	1.40	1.60	0.055	0.062
<b>D1</b>	1.00	1.25	0.039	0.049
<b>P0</b>	3.90	4.10	0.153	0.161
<b>10P0</b>	40.0+/- 0.20		1.574+/-0.007	
<b>W</b>	7.70	8.10	0.303	0.318
<b>P</b>	3.90	4.10	0.153	0.161
<b>A0</b>	2.14	2.34	0.084	0.092
<b>B0</b>	2.24	2.44	0.088	0.960
<b>K0</b>	1.12	1.32	0.044	0.052
<b>t</b>	0.27 max		0.010 max	

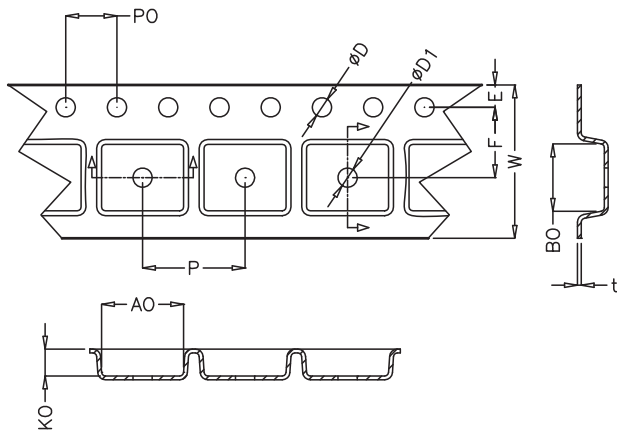
**Embossed Carrier Tape & Reel Specifications - SOT553 and SOT563**



	Millimetres		Inches	
	Min	Max	Min	Max
<b>E</b>	1.65	1.85	0.064	0.072
<b>F</b>	3.45	3.55	0.135	0.139
<b>P2</b>	1.95	2.05	0.076	0.080
<b>D</b>	1.40	1.60	0.055	0.062
<b>D1</b>	0.45	0.55	0.017	0.021
<b>P0</b>	3.90	4.10	0.153	0.161
<b>10P0</b>	40.0+/- 0.20		1.574+/-0.007	
<b>W</b>	7.70	8.10	0.303	0.318
<b>P</b>	3.90	4.10	0.153	0.161
<b>A0</b>	1.73	1.83	0.068	0.072
<b>B0</b>	1.73	1.83	0.068	0.072
<b>K0</b>	0.64	0.74	0.025	0.029
<b>t</b>	0.22 max		0.008 max	

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Embossed Carrier Tape & Reel Specification - MSOP-10



	Millimetres		Inches	
	Min	Max	Min	Max
<b>E</b>	1.65	1.85	0.064	0.072
<b>F</b>	5.40	5.60	0.212	0.220
<b>D</b>	1.50	1.60	0.059	0.062
<b>D1</b>	1.50 Min		0.059 Min	
<b>P0</b>	3.90	4.10	0.153	0.161
<b>10P0</b>	40.0+/- 0.20		1.574+/-0.007	
<b>W</b>	11.90	12.10	0.468	0.476
<b>P</b>	7.90	8.10	0.311	0.318
<b>A0</b>	5.20	5.40	0.204	0.212
<b>B0</b>	3.20	3.40	0.125	0.133
<b>K0</b>	1.20	1.40	0.047	0.055
<b>t</b>	0.30 +/- 0.05		0.011+/- 0.001	